

# APM2317AC-TRG-VB Datasheet

# P-Channel 20-V (D-S) MOSFET

| MOSFET PRODUCT SUMMARY |                                    |                                 |                       |  |  |
|------------------------|------------------------------------|---------------------------------|-----------------------|--|--|
| V <sub>DS</sub> (V)    | <b>R<sub>DS(on)</sub> (</b> Ω)     | I <sub>D</sub> (A) <sup>a</sup> | Q <sub>g</sub> (Typ.) |  |  |
|                        | 0.060 at V <sub>GS</sub> = - 10 V  | - 4.0                           |                       |  |  |
| - 20                   | 0.065 at V <sub>GS</sub> = - 4.5 V | - 3.5                           | 10 nC                 |  |  |
|                        | 0.080 at V <sub>GS</sub> = - 2.5 V | - 2.0                           |                       |  |  |

### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

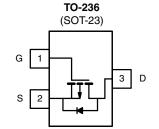
- · Load Switch
- PA Switch
- DC/DC Converters

| Parameter  |                                   | Symbol         | Limit                  | Unit |
|--|-----------------------------------|----------------|------------------------|------|
| Drain-Source Voltage                                 | V <sub>DS</sub>                   | - 20           | V                      |      |
| Gate-Source Voltage                                  | V <sub>GS</sub>                   | ± 12           |                        |      |
|  | T <sub>C</sub> = 25 °C            |                | - 4 <sup>e</sup>       |      |
| Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ ) | T <sub>C</sub> = 70 °C            | I <sub>D</sub> | -3.2                   |      |
|  | T <sub>A</sub> = 25 °C            | U.             | - 3 .5 <sup>b, c</sup> |      |
|  | T <sub>A</sub> = 70 °C            |                | - 2 .5 <sup>b, c</sup> | A    |
| Pulsed Drain Current                                 | I <sub>DM</sub>                   | - 10           |                        |      |
| Continuous Source-Drain Diode Current                | T <sub>C</sub> = 25 °C            | I <sub>S</sub> | - 2.1                  |      |
| Continuous Source-Drain Diode Current                | T <sub>A</sub> = 25 °C            | '5             | - 1.0 <sup>b, c</sup>  |      |
|  | T <sub>C</sub> = 25 °C            |                | 2.5                    |      |
| Maximum Power Dissipation                            | T <sub>C</sub> = 70 °C            | PD             | 1.6                    | w    |
|  | T <sub>A</sub> = 25 °C            | ' D            | 1.25 <sup>b, c</sup>   | vv   |
|  | T <sub>A</sub> = 70 °C            |                | 0.8 <sup>b, c</sup>    |      |
| Operating Junction and Storage Temperature Range     | T <sub>J</sub> , T <sub>stq</sub> | - 55 to 150    | °C                     |      |

| THERMAL RESISTANCE RATINGS                  |              |                   |         |         |      |  |  |
|---|--------------|-------------------|---------|---------|------|--|--|
| Parameter                                   |              | Symbol            | Typical | Maximum | Unit |  |  |
| Maximum Junction-to-Ambient <sup>b, d</sup> | ≤5 s         | R <sub>thJA</sub> | 75      | 100     | °C/W |  |  |
| Maximum Junction-to-Foot (Drain)            | Steady State | R <sub>thJF</sub> | 40      | 50      | C/W  |  |  |

Notes:

- a. Based on T<sub>C</sub> = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 166 °C/W.
- e. Package limited.



| MOSFET SPECIFICATIONS                         | -                       | , unless otherwise noted)  |       |        |       |       |  |
|---|-------------------------|--|-------|--------|-------|-------|--|
| Parameter                                     | Symbol                  | Test Conditions  | Min.  | Тур.   | Max.  | Unit  |  |
| Static  |                         |  |       |        |       |       |  |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>         | $V_{DS} = 0 V, I_{D} = -250 \mu A$   | - 20  |        |       | V     |  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$   | - Ι <sub>D</sub> = - 250 μΑ  |       | - 13.4 |       | mV/°C |  |
| V <sub>GS(th)</sub> Temperature Coefficient   | $\Delta V_{GS(th)}/T_J$ | - 6  |       | 2.9    |       |       |  |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_D = -250 \ \mu A$  | - 0.5 |        | - 1.5 | V     |  |
| Gate-Source Leakage                           | I <sub>GSS</sub>        | $V_{DS}$ = 0 V, $V_{GS}$ = ± 12 V  |       |        | ± 100 | nA    |  |
| Zero Gate Voltage Drain Current               | Inco                    | $V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}$   |       |        | - 1   |       |  |
| Zero Gale Vollage Drain Current               | IDSS                    | $V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C                                     |       |        | - 10  | μA    |  |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>      | $V_{DS} \leq$ - 5 V, $V_{GS}$ = - 4.5 V  | - 10  |        |       | А     |  |
|   |                         | V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3 A                                       |       | 0.060  |       |       |  |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>     | V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 2.5 A                                    |       | 0.065  |       | Ω     |  |
|   |                         | V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 2 A                                      |       | 0.080  |       |       |  |
| Forward Transconductance <sup>a</sup>         | 9 <sub>fs</sub>         | V <sub>DS</sub> = - 5 V, I <sub>D</sub> = - 3 A  |       | 15     |       | S     |  |
| Dynamic <sup>b</sup>                          | <b></b>                 |  |       |        |       |       |  |
| Input Capacitance                             | C <sub>iss</sub>        |  |       | 835    |       | pF    |  |
| Output Capacitance                            | C <sub>oss</sub>        | $V_{DS}$ = - 10 V, $V_{GS}$ = 0 V, f = 1 MHz   |       | 180    |       |       |  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>        |  |       | 155    |       |       |  |
| Tatal Cata Chauna                             | 0                       | $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.1 \text{ A}$              |       | 10     |       | - nC  |  |
| Total Gate Charge                             | Qg                      |  |       | 6.4    |       |       |  |
| Gate-Source Charge                            | Q <sub>gs</sub>         | $V_{DS} = -10 \text{ V}, V_{GS} = -2.5 \text{ V}, I_{D} = -3.1 \text{ A}$              |       | 1.7    |       |       |  |
| Gate-Drain Charge                             | Q <sub>gd</sub>         |  |       | 3.4    |       |       |  |
| Gate Resistance                               | Rg                      | f = 1 MHz  | 0.9   | 4.4    | 8.8   | Ω     |  |
| Turn-On Delay Time                            | t <sub>d(on)</sub>      |  |       | 22     | 33    |       |  |
| Rise Time                                     | t <sub>r</sub>          | $V_{DD}$ = - 10 V, $R_L$ = 2.4 $\Omega$  |       | 20     | 30    | ns    |  |
| Turn-Off Delay Time                           | t <sub>d(off)</sub>     | $I_D$ = - 3.1 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$                               |       | 28     | 42    |       |  |
| Fall Time                                     | t <sub>f</sub>          |  |       | 9      | 18    |       |  |
| Drain-Source Body Diode Characteristi         | cs                      |  |       |        |       |       |  |
| Continuous Source-Drain Diode Current         | ۱ <sub>S</sub>          | T <sub>C</sub> = 25 °C   |       |        | - 2.1 | A     |  |
| Pulse Diode Forward Current <sup>a</sup>      | I <sub>SM</sub>         |  |       |        | - 1 0 |       |  |
| Body Diode Voltage                            | V <sub>SD</sub>         | I <sub>S</sub> = - 3.1 A   |       | - 0.8  | - 1.2 | V     |  |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>         | -  |       | 23     | 35    | ns    |  |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>         |  |       | 12     | 20    | nC    |  |
| Reverse Recovery Fall Time                    | t <sub>a</sub>          | $I_F = -3.1 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$ |       | 15     |       |       |  |
| Reverse Recovery Rise Time                    | t <sub>b</sub>          | -  |       | 8      |       | ns    |  |

Notes:

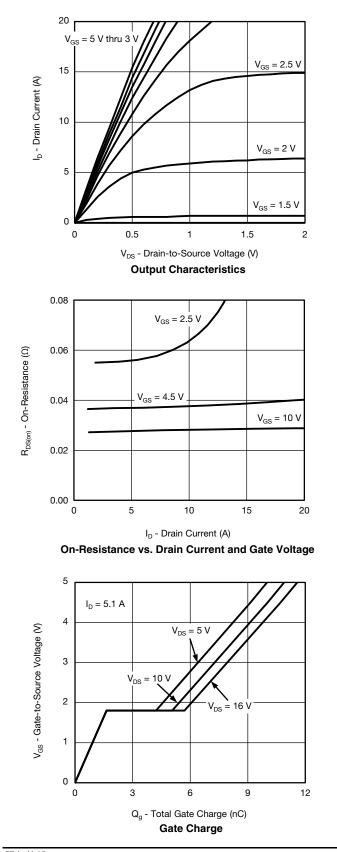
a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

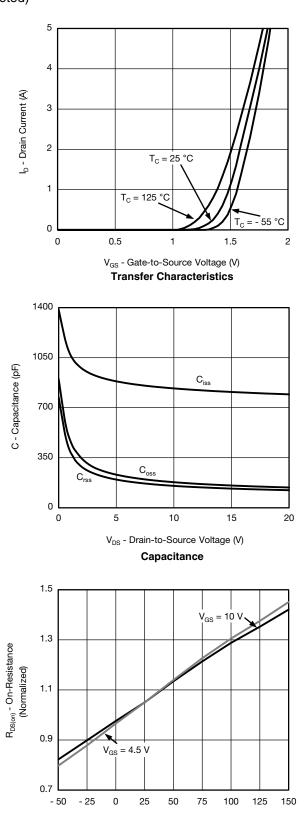
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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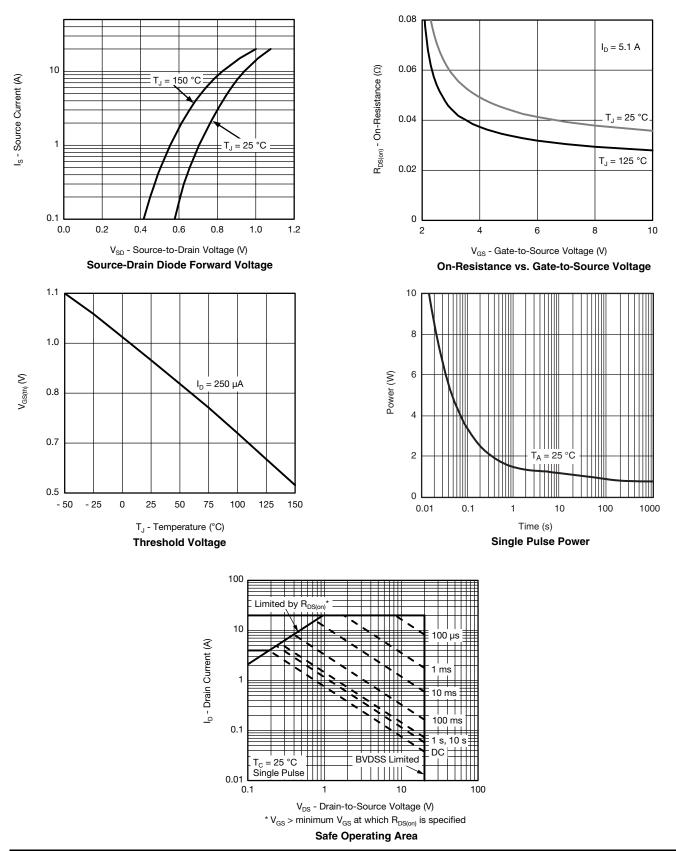




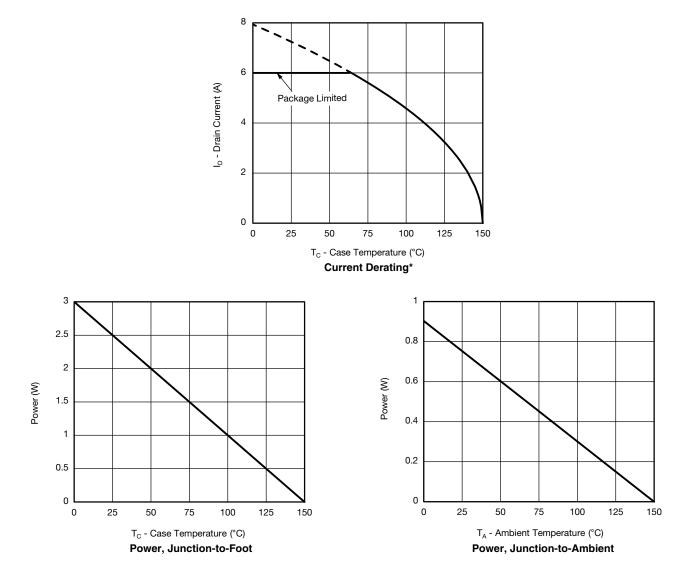
T<sub>J</sub> - Junction Temperature (°C)

**On-Resistance vs. Junction Temperature** 



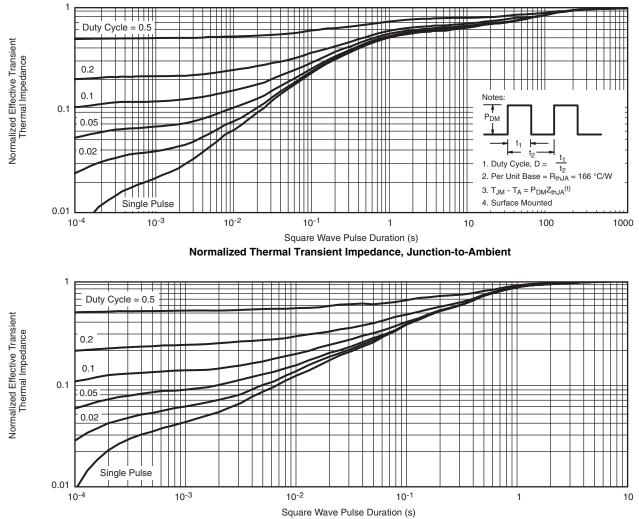






\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



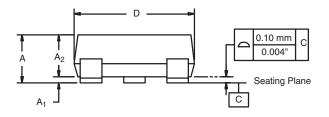


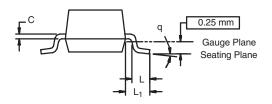
Normalized Thermal Transient Impedance, Junction-to-Foot



# SOT-23 (TO-236): 3-LEAD







| Dim                                   | MILLIN   | NETERS   | INCHES     |            |  |  |
|---------------------------------------|----------|----------|------------|------------|--|--|
|                                       | Min      | Max      | Min        | Max        |  |  |
| Α                                     | 0.89     | 1.12     | 0.035      | 0.044      |  |  |
| A <sub>1</sub>                        | 0.01     | 0.10     | 0.0004     | 0.004      |  |  |
| A <sub>2</sub>                        | 0.88     | 1.02     | 0.0346     | 0.040      |  |  |
| b                                     | 0.35     | 0.50     | 0.014      | 0.020      |  |  |
| С                                     | 0.085    | 0.18     | 0.003      | 0.007      |  |  |
| D                                     | 2.80     | 3.04     | 0.110      | 0.120      |  |  |
| E                                     | 2.10     | 2.64     | 0.083      | 0.104      |  |  |
| E <sub>1</sub>                        | 1.20     | 1.40     | 0.047      | 0.055      |  |  |
| е                                     | 0.95 BSC |          | 0.0374 Ref |            |  |  |
| e <sub>1</sub>                        | 1.90     | 1.90 BSC |            | 0.0748 Ref |  |  |
| L                                     | 0.40     | 0.60     | 0.016      | 0.024      |  |  |
| L <sub>1</sub>                        | 0.64 Ref |          | 0.025      | 0.025 Ref  |  |  |
| S                                     | 0.50 Ref |          | 0.020 Ref  |            |  |  |
| q                                     | 3°       | 8°       | 3°         | 8°         |  |  |
| ECN: S-03946-Rev. K, 09-<br>DWG: 5479 | Jul-01   | •        |            |            |  |  |

# APM2317AC-TRG-VB



## **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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